

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2401	257/758.ccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/27 06:25
L2	435	257/753.ccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/27 06:30
L3	851	257/762.ccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/27 06:30
L4	385	257/768.ccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/27 06:31
L5	1749	257/774.ccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/27 06:31
L6	1145	(Aggarwal.in. or Taylor.in. or Raghavan.in. or (Papa adj Rao).in. ) and copper	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/27 06:33
L7	24	(Aggarwal.in. or Taylor.in. or Raghavan.in. or (Papa adj Rao).in. ) and (copper adj interconnect)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/27 06:38
L8	20	7 and copper.clm.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/27 06:38
L9	26	(Aggarwal.in. or Taylor.in. or Raghavan.in. or (Papa adj Rao).in. ) and (copper adj interconnect)	US-PGPUB	OR	ON	2005/06/27 06:42
L10	0	9 and copper.clm.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/27 06:38
L11	3	9 and ruthenium	US-PGPUB	OR	ON	2005/06/27 06:44
L12	0	8 and ruthenium	US-PGPUB	OR	ON	2005/06/27 06:44
S1	1430	(copper with interconnect) and barrier and semiconductor and substrate and dielectric and trench	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 06:34

S2	72	S1 and (barrier with (iridium or ruthenium or rhodium or rhenium or platinum or palladium))	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 06:47
S3	67	S2 and via	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 06:36
S4	1	S1 and (barrier with ((iridium adj oxide) or (ruthenium adj oxide) or (rhodium adj oxide) or (rhenium adj oxide) or (platinum adj oxide) or (palladium adj oxide)))	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 06:45
S5	64	S1 and (barrier with (iridium or ruthenium or rhodium or rhenium or platinum or palladium)) and oxide	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 06:47
S6	61	S5 and via	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 06:47
S7	37	S6 and copper.ab	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 06:52
S8	23	S7 and (barrier with oxide)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 06:53
S9	62	copper and (barrier with ((iridium adj oxide) or (ruthenium adj oxide) or (rhodium adj oxide) or (rhenium adj oxide) or (platinum adj oxide) or (palladium adj oxide)))	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 17:25
S10	14	S9 and damascene	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 17:25